# International IOR Rectifier

# **POWER MOSFET** THRU-HOLE (TO-257AA)

# IRFY240C, IRFY240CM 200V, N-CHANNEL **HEXFET® MOSFET TECHNOLOGY**

#### **Product Summary**

Part Number	RDS(on)	ΙD	Eyelets		
IRFY240C	0.18 Ω	16A	Ceramic		
IRFY240CM	0.18 Ω	16A	Ceramic		

HEXFET® MOSFET technology is the key to International Rectifier's advanced line of power MOSFET transistors. The efficient geometry design achieves very low on-state resistance combined with high transconductance. HEXFET transistors also feature all of the well-established advantages of MOSFETs, such as voltage control, very fast switching, ease of paralleling and electrical parameter temperature stability. They are well-suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers, high energy pulse circuits, and virtually any application where high reliability is required. The HEXFET transistor's totally isolated package eliminates the need for additional isolating material between the device and the heatsink. This improves thermal efficiency and reduces drain capacitance.



#### Features:

- Simple Drive Requirements
- Ease of Paralleling
- Hermetically Sealed
- Electrically Isolated
- Ceramic Eyelets
- Ideally Suited For Space Level **Applications**

## **Absolute Maximum Ratings**

	Parameter		Units	
ID @ VGS = 10V, TC = 25°C	Continuous Drain Current	16		
ID @ VGS = 10V, TC = 100°C   Continuous Drain Current		10.2	Α	
I <sub>DM</sub>	Pulsed Drain Current ①	64		
P <sub>D</sub> @ T <sub>C</sub> = 25°C	Max. Power Dissipation	100	W	
	Linear Derating Factor	0.8	W/°C	
VGS	Gate-to-Source Voltage	±20	V	
EAS	Single Pulse Avalanche Energy ②	580	mJ	
IAR	Avalanche Current ①	16	Α	
EAR	Repetitive Avalanche Energy ①	10	mJ	
dv/dt	Peak Diode Recovery dv/dt 3	5.0	V/ns	
TJ	Operating Junction	-55 to 150		
TSTG Storage Temperature Range			°C	
	Lead Temperature	300(0.063in./1.6mm from case for 10 sec)		
	Weight	4.3 (Typical)	g	

For footnotes refer to the last page

### Electrical Characteristics @ Tj = 25°C (Unless Otherwise Specified)

	Parameter	Min	Тур	Max	Units	Test Conditions		
BVDSS	Drain-to-Source Breakdown Voltage	200	_	_	V	VGS = 0V, ID = 1.0mA		
ΔBV <sub>DSS</sub> /ΔT <sub>J</sub>	Temperature Coefficient of Breakdown Voltage	_	0.29	_	V/°C	Reference to 25°C, I <sub>D</sub> = 1.0mA		
RDS(on)	Static Drain-to-Source On-State Resistance	_	_	0.18	Ω	VGS = 10V, ID = 10.2A <sub>④</sub>		
VGS(th)	Gate Threshold Voltage	2.0	_	4.0	V	$V_{DS} = V_{GS}$ , $I_{D} = 250\mu A$		
9fs	Forward Transconductance	6.1	_	_	S (7)	V <sub>DS</sub> > 15V, I <sub>DS</sub> = 10.2A ④		
IDSS	Zero Gate Voltage Drain Current		_	25	μΑ	VDS= 160V ,VGS=0V		
			_	250	μΑ	V <sub>DS</sub> = 160V,		
						$V_{GS} = 0V, T_{J} = 125^{\circ}C$		
IGSS	Gate-to-Source Leakage Forward	_	_	100	nA	VGS = 20V		
IGSS	Gate-to-Source Leakage Reverse		_	-100	nA nA	Vgs = -20V		
Qg	Total Gate Charge	_	_	60		VGS =10V, ID = 16A		
Qgs	Gate-to-Source Charge	_	_	10.6	nC	VDS = 50V		
Q <sub>gd</sub>	Gate-to-Drain ('Miller') Charge	_	_	37.6				
<sup>t</sup> d(on)	Turn-On Delay Time	_	_	20		$V_{DD} = 100V, I_D = 16A,$		
tr	Rise Time	_	_	152	ns	$V_{GS} = 10V$ , $R_{G} = 9.1\Omega$		
td(off)	Turn-Off Delay Time	_	_	58	115			
tf	FallTime		_	67				
LS+LD	Total Inductance	_	6.8	_	nH	Measured from drain lead (6mm/0.25in. from package) to source lead (6mm/0.25in. from package)		
C <sub>iss</sub>	Input Capacitance	_	1300	_		VGS = 0V, VDS = 25V		
Coss	Output Capacitance	_	400	_	pF	f = 1.0MHz		
C <sub>rss</sub>	Reverse Transfer Capacitance	_	130	_				

# **Source-Drain Diode Ratings and Characteristics**

	Parameter		Min	Тур	Max	Units	Test Conditions
Is	Continuous Source Current (Body Diode)		_	_	16	۸	
ISM	Pulse Source Current (Body Diode) ①		_	_	64	Α	
VSD	Diode Forward Voltage		_	_	1.5	V	$T_j = 25$ °C, $I_S = 16A$ , $V_{GS} = 0V$ ④
trr	Reverse Recovery Time		_	_	500	nS	Tj = 25°C, IF = 16A, di/dt ≤ 100A/μs
QRR	Reverse Recovery Charge		_	_	5.3	μC	V <sub>DD</sub> ≤ 50V ④
ton	Forward Turn-On Time	Intrinsic turn-on time is negligible. Turn-on speed is substantially controlled by LS + LD.					

## **Thermal Resistance**

	Parameter	Min	Тур	Max	Units	Test Conditions
RthJC	Junction-to-Case	_	_	1.25		
RthCS	Case-to-sink	_	0.21	_	°C/W	
R <sub>th</sub> JA	Junction-to-Ambient	_	_	80		Typical socket mount

Note: Corresponding Spice and Saber models are available on International Rectifier Website. For footnotes refer to the last page

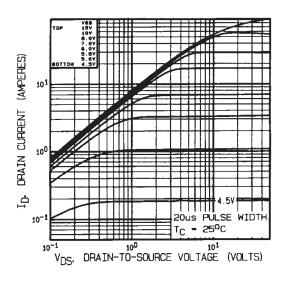


Fig 1. Typical Output Characteristics

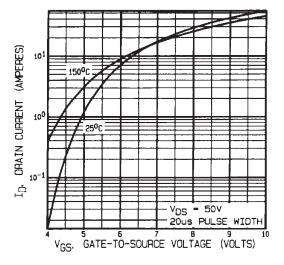


Fig 3. Typical Transfer Characteristics

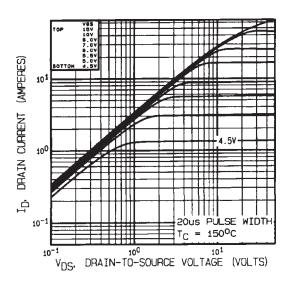
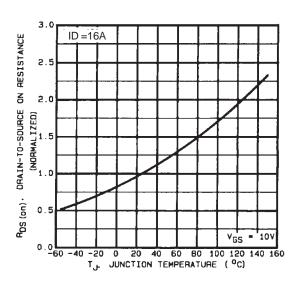
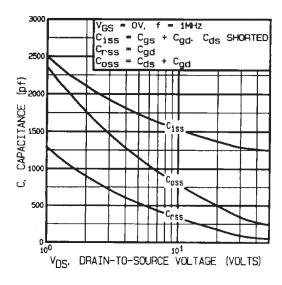


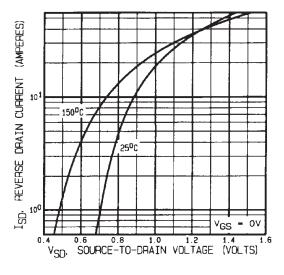
Fig 2. Typical Output Characteristics



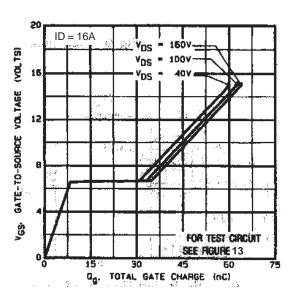
**Fig 4.** Normalized On-Resistance Vs. Temperature



**Fig 5.** Typical Capacitance Vs. Drain-to-Source Voltage



**Fig 7.** Typical Source-Drain Diode Forward Voltage



**Fig 6.** Typical Gate Charge Vs. Gate-to-Source Voltage

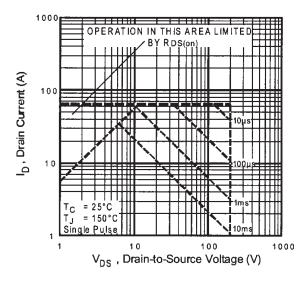
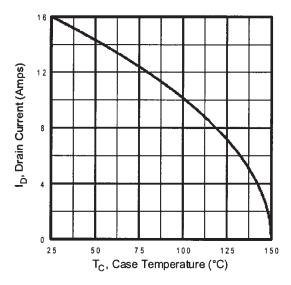


Fig 8. Maximum Safe Operating Area



**Fig 9.** Maximum Drain Current Vs. Case Temperature

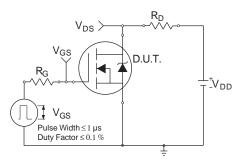


Fig 10a. Switching Time Test Circuit

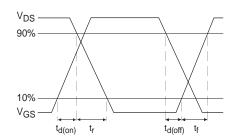


Fig 10b. Switching Time Waveforms

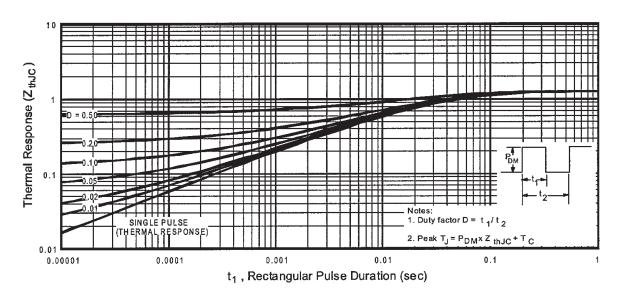


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

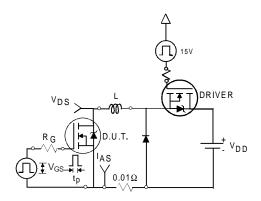


Fig 12a. Unclamped Inductive Test Circuit

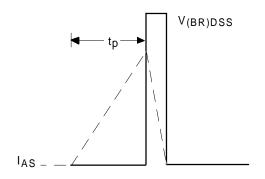


Fig 12b. Unclamped Inductive Waveforms

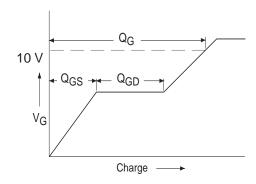


Fig 13a. Basic Gate Charge Waveform

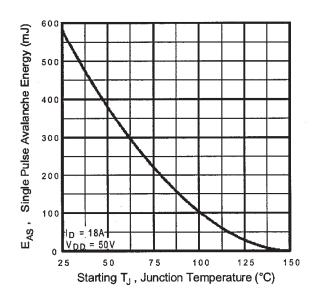


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

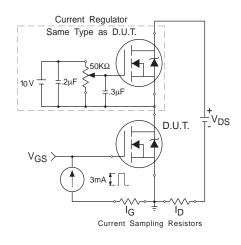


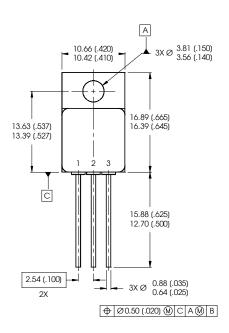
Fig 13b. Gate Charge Test Circuit

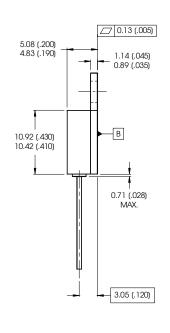
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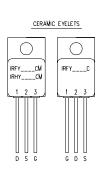
#### Footnotes:

- ① Repetitive Rating; Pulse width limited by maximum junction temperature.
- $^{\circ}$  V<sub>DD</sub> = 50V, starting T<sub>J</sub> = 25°C, L= 4.5mH Peak I<sub>L</sub> = 16A, V<sub>GS</sub> = 10V
- $\label{eq:interpolation} \begin{array}{ll} \text{(3)} & I_{SD} \leq 16A, \ di/dt \leq 150A/\mu s, \\ & V_{DD} \leq 200V, \ T_{J} \leq 150^{\circ}C \end{array}$
- 4 Pulse width  $\leq 300 \ \mu s$ ; Duty Cycle  $\leq 2\%$

#### Case Outline and Dimensions — TO-257AA







#### NOTES:

- 1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M-1994.
- 2. CONTROLLING DIMENSION: INCH.
- 3. DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).
- 4. OUTLINE CONFORMS TO JEDEC OUTLINE TO-257AA.

#### LEGEND

- D DRAIN
- S SOURCE
- G GATE

# International Rectifier

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